## Multilayer Ceramic Chip Capacitors

# 1 of 3 Creation Date : May 16, 2017 (GMT)

#### C2012X5R1V106M125AC



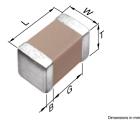






#### **TDK item description** C2012X5R1V106MT\*\*\*\*

Applications	Commercial Grade	
Feature	General General (Up to 50V)	
Series	C2012 [EIA 0805]	
Status	Production	



Size			
Length(L)	2.00mm ±0.20mm		
Width(W)	1.25mm ±0.20mm		
Thickness(T)	1.25mm ±0.20mm		
Terminal Width(B)	0.20mm Min.		
Terminal Spacing(G)	0.50mm Min.		
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering)		
necommended Land Fattern (FA)	0.90mm to 1.20mm(Reflow Soldering)		
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering)		
neconinenced Land ( attent (FB)	0.70mm to 0.90mm(Reflow Soldering)		
Pacammandad Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering)		
Recommended Land Pattern (PC)	0.90mm to 1.20mm(Reflow Soldering)		

Electrical Characteristics		
Capacitance	10μF ±20%	
Rated Voltage	35VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	50ΜΩ	

Other		
Coldaring Mathed	Wave (Flow)	
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	2000pcs	

<sup>!</sup> Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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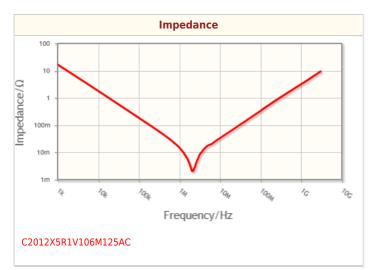


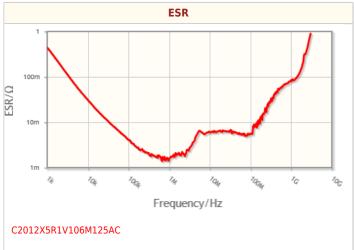


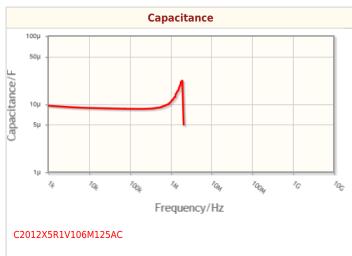


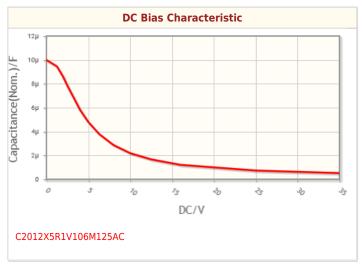


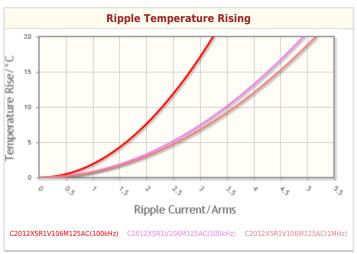
## Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)











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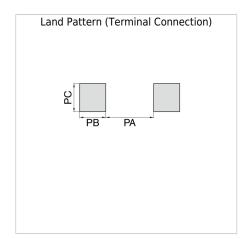








# **Associated Images**



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